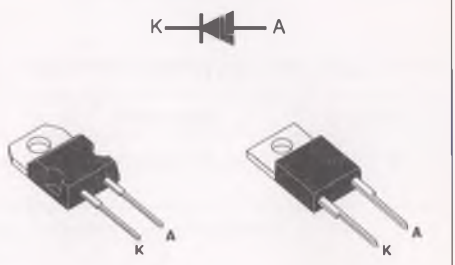
SGS-THOMSON MICROELECTRONICS

STTA806D(I)

TURBOSWITCH ™ "A". ULTRA-FAST HIGH VOLTAGE DIODE

MAIN PRODUCTS CHARACTERISTICS

$I_{F(AV)}$	8A
V_{RRM}	600V
t_{rr} (typ)	25ns
V_F (max)	1.5V



TO220AC (Plastic) **STTA806D**

Isolated TO220AC (Plastic) **STTA806DI**

FEATURES AND BENEFITS

- SPECIFIC TO "FREEWHEEL MODE" OPERATIONS: Freewheel or Booster Diode.
- ULTRA-FAST RECOVERY.
- VERY LOW OVERALL POWER LOSSES IN BOTH THE DIODE AND THE COMPANION TRANSISTOR.
- HIGH FREQUENCY OPERATIONS.

DESCRIPTION

The TURBOSWITCH is a very high performance series of ultra-fast high voltage power diodes from 600V to 1200V.
TURBOSWITCH, A family, drastically cuts losses in both the diode and the associated switching IGBT or MOSFET in all "Freewheel Mode" operations and is particularly suitable and efficient in Motor Control Freewheel applications and in Booster diode applications in Power Factor Control circuitries.
Packaged in TO220AC and in isolated TO220AC, these 600V devices are particularly intended for use on 240V domestic mains.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{RRM}	Repetitive peak reverse voltage	600	V
V_{RSM}	Non repetitive peak reverse voltage	600	V
$I_{F(RMS)}$	RMS forward current	20	A
I_{FRM}	Repetitive peak forward current (tp = 5 µs, f = 5kHz)	120	A
T_j	Max operating junction temperature	-65 to 150	°C
T_{stg}	Storage temperature	-65 to 150	°C

TM : TURBOSWITCH is a trademark of SGS-THOMSON Microelectronics.

THERMAL AND POWER DATA

Symbol	Parameter	Conditions	Value	Unit
$R_{th(j-c)}$	Junction to case thermal resistance	STTA806D STTA806DI	2.2 3.3	°C/W
P_1	Conduction power dissipation (see fig. 2)	$I_{F(AV)}$ = 8A δ =0.5 STTA806D Tc= 118°C STTA806DI Tc= 102°C	14.5	W
P_{max}	Total power dissipation Pmax = P1 + P3 (P3 = 10% P1)	STTA806D Tc= 115°C STTA806DI Tc= 97°C	16	W

STATIC ELECTRICAL CHARACTERISTICS (see Fig.2)

Symbol	Parameter	Test Conditions		Min	Typ	Max	Unit
V_F *	Forward voltage drop	I_F =8A	Tj = 25°C Tj = 125°C			1.75 1.5	V V
I_R **	Reverse leakage current	V_R =0.8 x V_{RRM}	Tj = 25°C Tj = 125°C			100 4	µA mA

Test pulses widths : * tp = 380 µs, duty cycle < 2%
** tp = 5 ms , duty cycle < 2%

DYNAMIC ELECTRICAL CHARACTERISTICS

TURN-OFF SWITCHING (see Fig.3)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
t_{rr}	Reverse recovery time	Tj = 25°C I_F = 0.5 A I_R = 1A Irr = 0.25A I_F = 1 A dI_F/dt =-50A/µs V_R =30V		25	52	ns
I_{RM}	Maximum reverse recovery current	Tj = 125°C VR = 400V I_F =8A dI_F/dt = -64 A/µs dI_F/dt = -500 A/µs		14	5.5	A
S factor	Softness factor	Tj = 125°C V_R = 400V I_F =8A dI_F/dt = -500 A/µs		0.47		/

TURN-ON SWITCHING (see Fig.4)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
t_{fr}	Forward recovery time	Tj = 25°C I_F =8 A, dI_F/dt = 64 A/µs measured at, 1.1 × $V_F$max			500	ns
V_{Fp}	Peak forward voltage	Tj = 25°C I_F =8A, dI_F/dt = 64 A/µs			10	V

APPLICATION DATA

The TURBOSWITCH "A" is especially designed to provide the lowest overall power losses in any "FREEWHEEL Mode" application (Fig.1) considering both the diode and the companion transistor, thus optimizing the overall performance in the end application.

The way of calculating the power losses is given below:

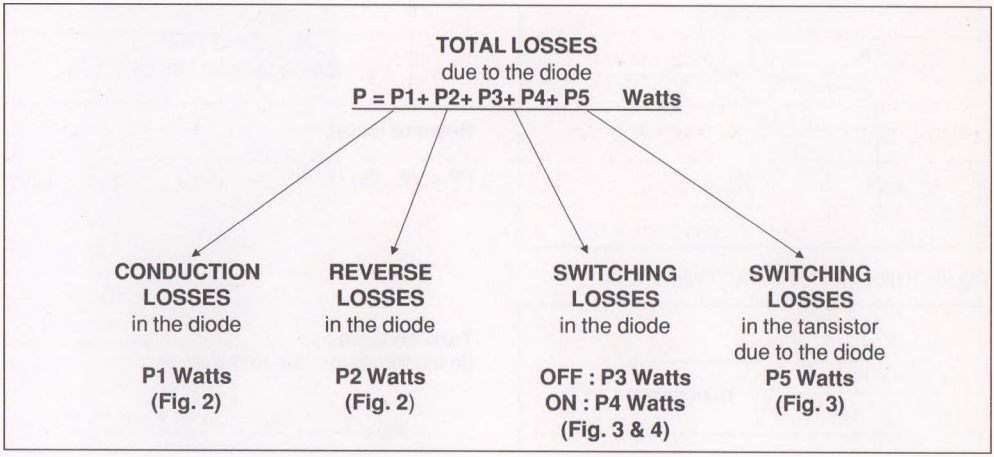
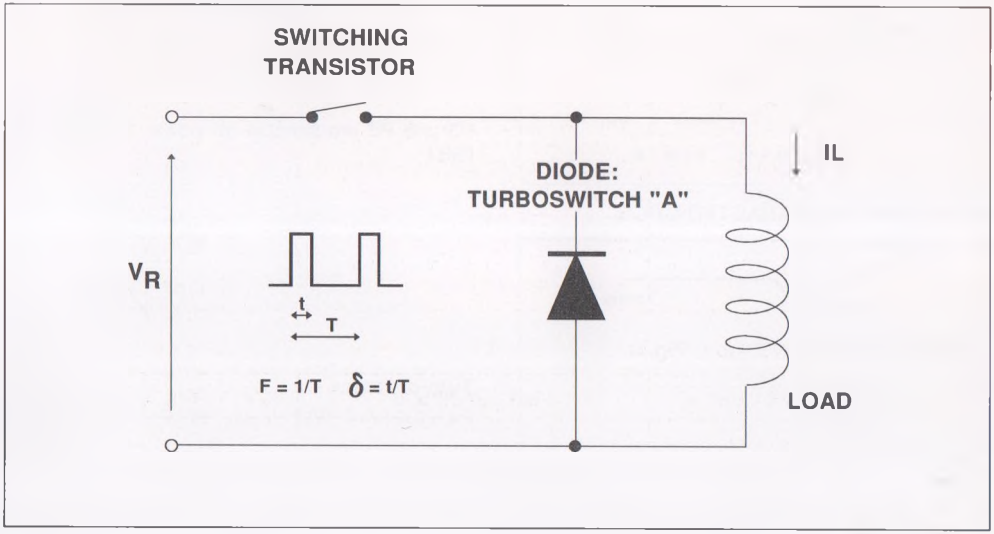
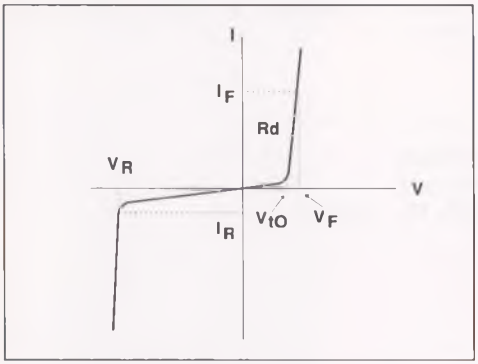


Fig. 1 : "FREEWHEEL" MODE.



APPLICATION DATA (Cont'd)

Fig. 2: STATIC CHARACTERISTICS



Conduction losses :

$P1 = V_{t0} . I_{F(AV)} + R_d . I_F^2{}_{(RMS)}$

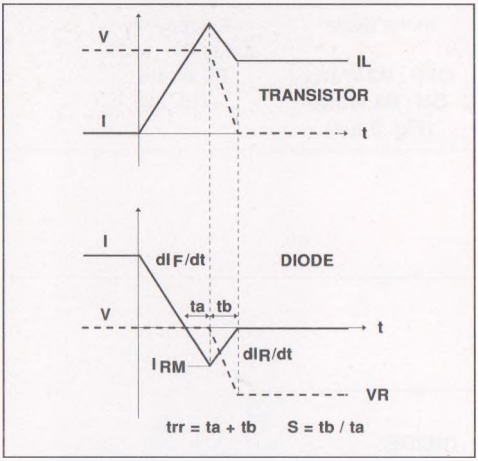
with

$V_{t0} = 1.15$ V
$R_d = 0.043$ Ohm
(Max values at 125°C)

Reverse losses :

$P2 = V_R . I_R . (1 - \delta)$

Fig. 3: TURN-OFF CHARACTERISTICS



Turn-on losses :
(in the transistor, due to the diode)

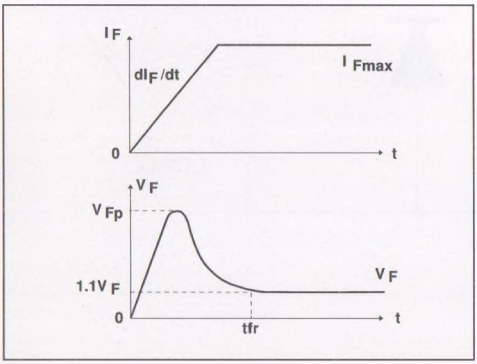
$$P5 = \frac{V_R \times I_{RM}{}^2 \times (3 + 2 \times S) \times F}{6 \times dI_F/dt} + \frac{V_R \times I_{RM} \times I_L \times (S + 2) \times F}{2 \times dI_F/dt}$$

Turn-off losses (in the diode) :

$$P3 = \frac{V_R \times I_{RM}{}^2 \times S \times F}{6 \times dI_F/dt}$$

P3 and P5 are suitable for power MOSFET and IGBT

Fig. 4: TURN-ON CHARACTERISTICS



Turn-on losses :

$P4 = 0.4 (V_{FP} - V_F) . I_{Fmax} . t_{fr} . F$

Fig 5 : Conduction losses versus average current

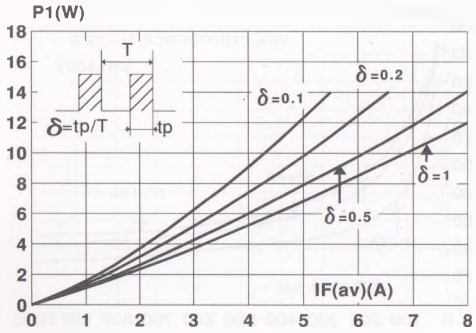


Fig 6 : Switching OFF losses versus dIF/dt

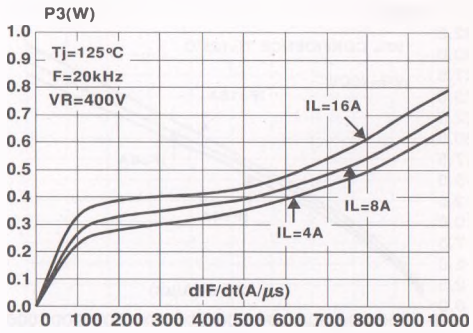


Fig 7 : Switching ON losses versus dIF/dt

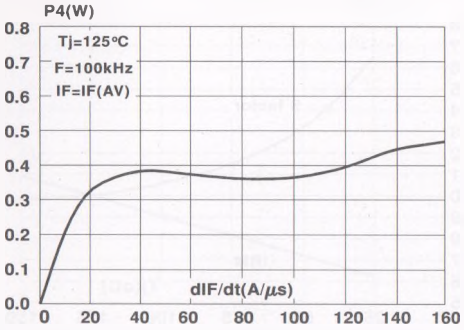


Fig 8 : Switching losses in transistor due to the diode

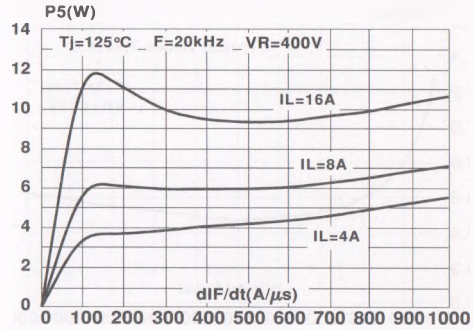


Fig 9 : Forward voltage drop versus forward current

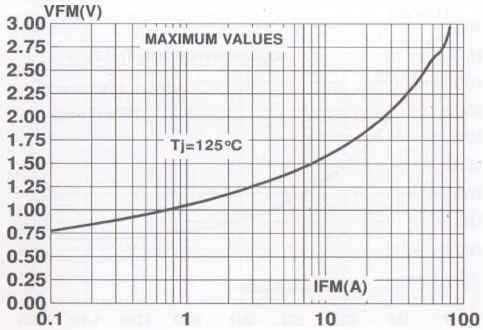


Fig 10 : Relative variation of thermal transient impedance junction to case versus pulse duration

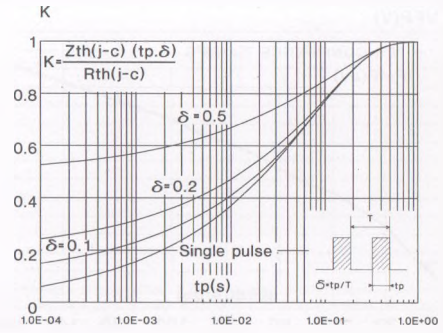


Fig 11 : Peak reverse recovery current versus dIF/dt

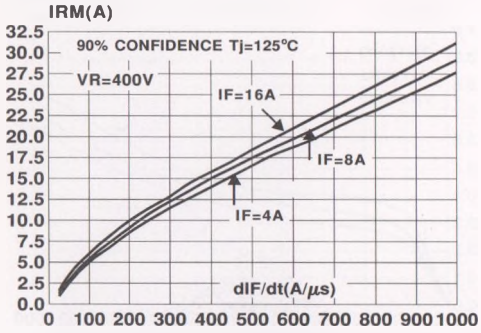


Fig 12 : Reverse recovery time versus dIF/dt

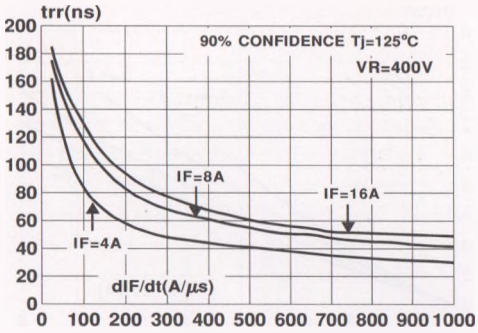


Fig 13 : Softness factor (tb/ta) versus dIF/dt

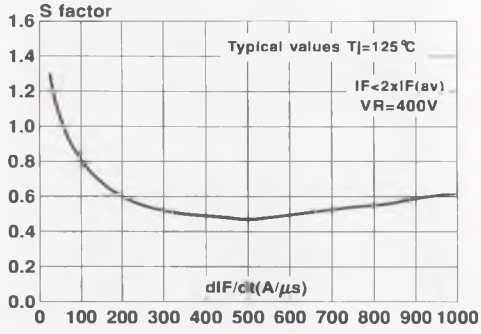


Fig 14 : Relative variation of dynamic parameters versus junction temperature (Reference Tj=125°C)

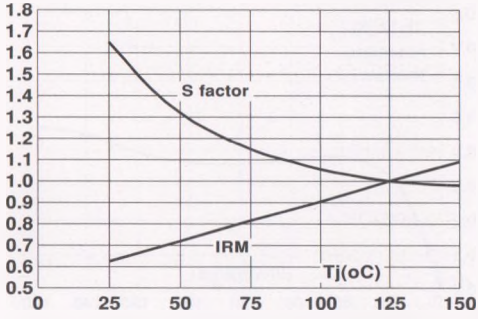


Fig 15 : Transient peak forward voltage versus dIF/dt

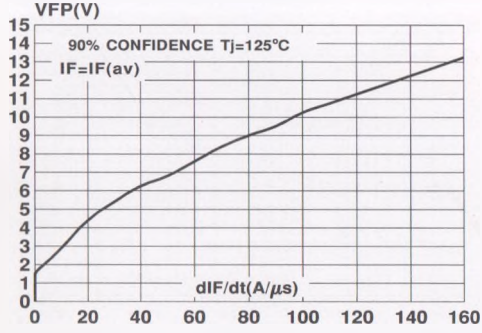


Fig 16 : Forward recovery time versus dIF/dt